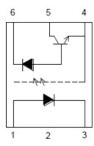




• Description

The KT050L series consists of a high efficient AlGaAs Light Emitting Diode and a high speed optical detector. This design provides excellent AC and DC isolation between the input and output sides of the photo coupler. The output of the optical detector features an open collector Schottky clamped transistor. The internal shield ensures high common mode transient immunity. A guaranteed common mode transient immunity is up to $15KV/\mu s$ (min.). The photo coupler operational parameters are guaranteed over the temperature range from $-55^{\circ}C \sim +110^{\circ}C$.





1. Anode	4. GND	

6. Vcc

2. N.C. 5. Vo (Voltage Output)

3. Cathode

- Features
 - 1. High speed 1MBd typical
 - 2. Package creepage at 8mm
 - 3. Compatible with infrared vapor phase reflow and wave soldering process
 - Very high common mode transient immunity: 15K V/µs at VCM = 1500 V
 - 5. Guarantee performance from temperature range: -55°C to 110°C
 - 6. TTL compatible
 - 7. Open collector output

• Applications

- Digital signal isolation
- Communications interface
- Micro-controller interface
- Feedback elements in switching power supplies
- Digital isolation for A/D, D/A conversion Digital field

• Truth Table

LED	OUT
ON	L
OFF	н

Note: A 0.1μ F bypass capacitor must be connected between Pin 4 and 6.

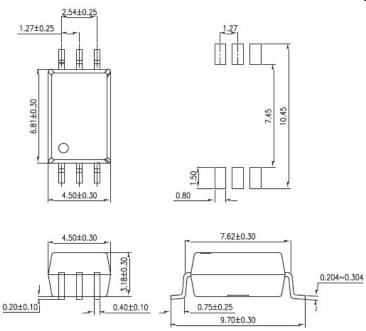


• Outside Dimension

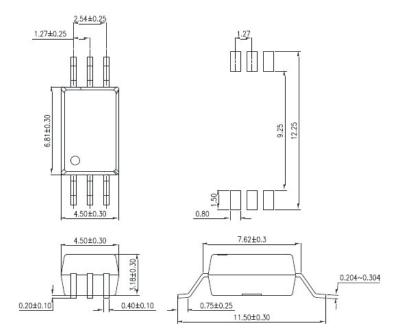
1. P Type

Surface Mount Lead Forming

Unit : mm

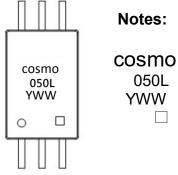


2. W Type





Device Marking



Y: Year code / WW: Week code V or None : VDE option

• Al	osolute Maximum Ratings				(Ta = 25°C)
	Parameter		Symbol	Rating	Unit
lasut	Forward current		I _F	20	mA
Input	Reverse voltage		V _R	5	V
	Output current	Ι _ο	8	mA	
O 1 1	Output voltage		Vo	20	V
Output	Peak Output Current		Ι _Ο	16	mA
	Supply Voltage		Vcc	30	V
Junctior	n temperature		Tj	125	°C
Storage	Temperature		Tstg	125	С°
Operati	ng Temperature		Topr	110	°C
Total Pa	ackage Power Dissipation		Рт	145	mW
Lead so	oldering temperature(10s)	(Note 2)	T _{sol}	260	С°
Isolatior	n voltage (AC,1min.,R.H≦60%)	(Note 3)	BVs	5000	Vrms

Note 1: Pulse width $Pw \leq 1\mu s$,300pps.

Note 2: It is 2 mm or more from a lead root.

Note 3: Device is considered as a two terminal device: Pin1,2 and 3 shorted together, and pins 4,5 and 6 shorted together.



15

33

Electrical Characteri	stics				(Ta =	= 25°C)
Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Input Forward Voltage	VF	I _F =16mA, T _A =25 °C	1.2	1.4	1.8	V
Input Reverse Voltage	BVr	Ir = 10μΑ	5	-	-	V
Logic high supply current	I _{CCH}	I _F = 0mA, V _O = open ; T _A = 25°C (V _{CC} = 30V)	-	0.002	1	μ A
Logic low supply current	I _{CCL}	I _F = 16mA, V _o = open (V _{cc} =30V)	-	165	-	μ A
		$I_F = 0mA, V_O = V_{CC} = 5.5V,$ $T_A = 25^{\circ}C$		0.002	0.5	μ A
Logic high output current	I _{ОН}	I _F = 0mA, V _O = V _{CC} = 15V T _A = 25°C	-	0.005	1	μΑ
		T _A = 0 ~ 70°C	-	-	50	μ A
Logic low output voltage	V _{OL}	I _F = 16mA;V _{CC} = 4.5V; I _O = 3.0mA; T _A = 25°C	-	0.2	0.4	V
output voltage	V _{OL}	I _F = 16mA;V _{CC} = 4.5V; I _O = 2.4mA; T _A = 25°C	-	0.5	V	
Current transfer ratio	CTD	I _F = 16mA; V _{CC} = 4.5V; T _A = 25 °C; V _O = 0.4V	20	32	-	0/
Current transfer ratio	CTR	I _F = 16mA; V _{CC} = 4.5V;	15	33	-	%

Specified over recommended temperature (TA = -40°C to +110°C, +4.5V ≤ VCC ≤ 30V), IF(ON) = 1.6mA to 5mA, VF(OFF) = 0V to 0.8V, unless otherwise specified. All typicals at TA = 25° C.

 $T_A = 25^{\circ}C; V_O = 0.5V$

Note 1: Duration of output short circuit time should not exceed 10 μ s.

Note 2: Input capacitance is measured between pin 1 and pin 3.



Switching Character	(Ta = 25°C)					
Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Propagation Delay Time to Output Low Level	t _{PHL}		-	35	75	
Propagation Delay Time to Output High Level	t _{PLH}	VCC = 5V, IF = 7.5 mA,	-	60	75	ns
Pulse Width Distortion	PWD	RL = 350Ω, CL = 15 pF	-	25	40	
Rise Time	t _r		-	30	-	
Fall Time	t _f		-	3	-	
Common mode transient immunity at high level output	C _{MH}	VCC = 5V, IF = 0 mA, VO(MIN) = 2V,RL = 350Ω, VCM = 1000V	10	15	-	KV / μs
Common mode transient immunity at low level output	C _{ML}	VCC = 5V, IF = 7.5 mA, VO(MAX) = 0.8V,RL = 350Ω, VCM = 1000V	10	15	-	KV / µs

Over recommended operating conditions TA = -40° C to 105° C, VCC = +4.5 V to 30 V, IF(ON) = 1.6 mA to 5 mA, VF(OFF) = 0 V to 0.8 V, unless otherwise specified. All typicals at TA = 25° C.

Note 1: The tPLH propagation delay is measured from the 50% point on the leading edge of the input pulse to the 1.3 V point on the leading edge of the output pulse. The tPHL propagation delay is measured from the 50% point on the trailing edge of the input pulse to the 1.3 V point on the trailing edge of the output pulse.

Note 2: Pulse Width Distortion (PWD) is defined as |tPHL - tPLH | for any given device.

Note 3: The difference of tPLH and tPHL between any two devices under the same test condition.

Note 4: CMH is the maximum slew rate of the common mode voltage that can be sustained with the output voltage in the logic high state, VO > 2.0 V. CML is the maximum slew rate of the common mode voltage that can be sustained with the output voltage in the logic low state, VO < 0.8 V. Note: Equal value split resistors (Rin/2) must be used at both ends of the LED.



KT050L Series

LSOP 6 High Speed 1MBit/s PHOTOCOUPLER

TYPICAL PERFORMANCE CURVES & TEST CIRCUITS



Fig.2 Input Current vs. Forward Voltage

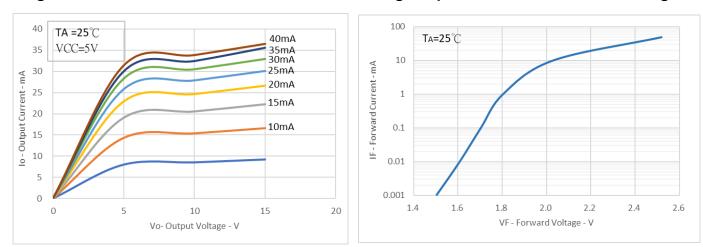


Fig.3 Propagation Delay vs. Load Resistance Fig.4 Current Transfer Ratio vs. Input Current

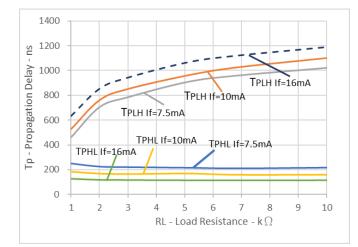
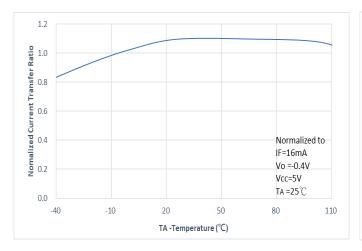
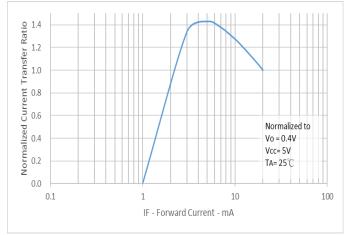


Fig.5 Current Transfer Ration vs. Temperature







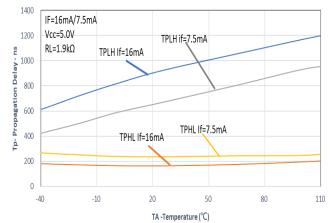




Fig.8 Frequency Response

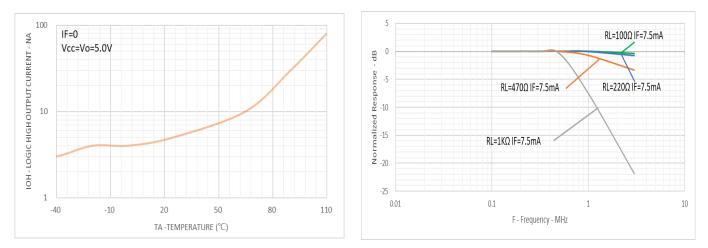
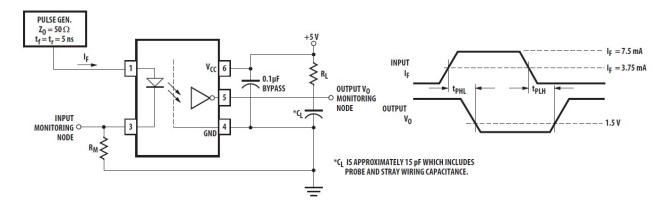


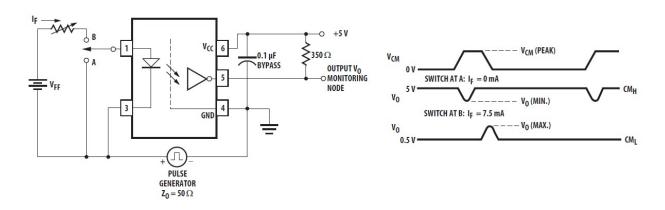
Fig.7 Logic High Output Current vs. Temperature

• Test Circuit

Propagation delay time tPLH \ tPHL \ and rise time tr, fall time tf



Common Mode Transient Immunity Test Circuit and Typical Waveforms



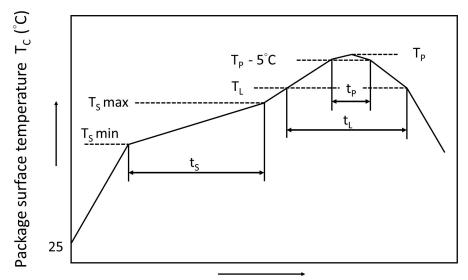
 $C_{ML}(C_{MH})$ is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.



• Recommended Soldering Conditions

IR Reflow soldering

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



Recommended Temperature Profile of Infrared Reflow

Lime (S)

	Symbol	Min	Max	Unit
Preheat temperature	Τs	150	200	°C
Preheat time	t _s	60	120	s
Ramp-up rate $(T_L \text{ to } T_P)$			3	°C/s
Liquidus temperature	TL	21	17	°C
Time above T_{L}	tL	60	100	S
Peak Temperature	Τ _Ρ		260	°C
Time during which T_{C} is	+		20	0
between (T $_{\rm P}$ - 5) and T $_{\rm P}$	t _P		20	S
Ramp-down rate			6	°C/s



• Numbering System

KT050L X (Y)-(Z)

Notes:

KT050 = Part No.

X = Lead form option (P or W)

Y = Tape and reel option (TLD or TRU)

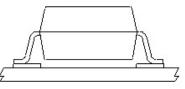
Z = VDE option (V or None)

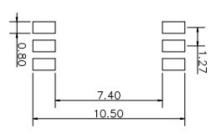
Option	Description	Packing quantity
P (TLD)	surface mount type package + TL tape & reel option	3000 units per reel
P (TRU)	surface mount type package + TR tape & reel option	3000 units per reel
W (TLD)	long creepage distance for surface mount type package + TLD tape & reel option	3000 units per reel
W (TRU)	long creepage distance for surface mount type package + TRU tape & reel option	3000 units per reel

• Recommended Pad Layout for Surface Mount Lead Form

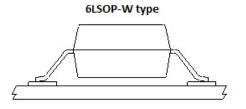
1. Surface mount type

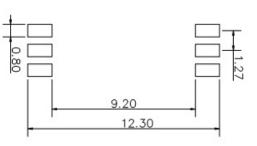






2.Long creepage distance for surface mount type

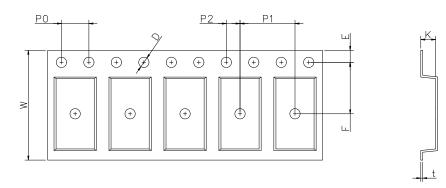




Unit :mm

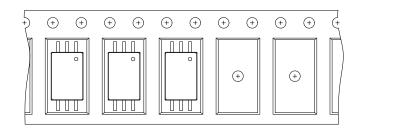


• LSOP 6 Carrier Tape & Reel

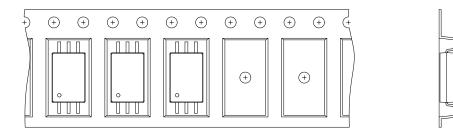


Dimension Symbol	D	E	F	P0	P1	P2	t	W	К
P type Dimension (mm)	1.5±0.1	1.75±0.1	7.5±0.1	4.0±0.1	8.0±0.1	2.0±0.1	0.3±0.1	16.0±0.3	2.15±0.1
W type Dimension (mm)	1.5±0.1	1.75±0.1	11.5±0.1	4.0±0.1	8.0±0.1	2.0±0.1	0.3±0.1	24.0±0.3	2.52±0.1

TRU



TLD





• Application Notice

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